

< Silicon RF Power MOS FET (Discrete) >

RD08MUS2

RoHS Compliance, Silicon MOSFET Power Transistor, 527MHz, 7.5W, 7.2V

DESCRIPTION

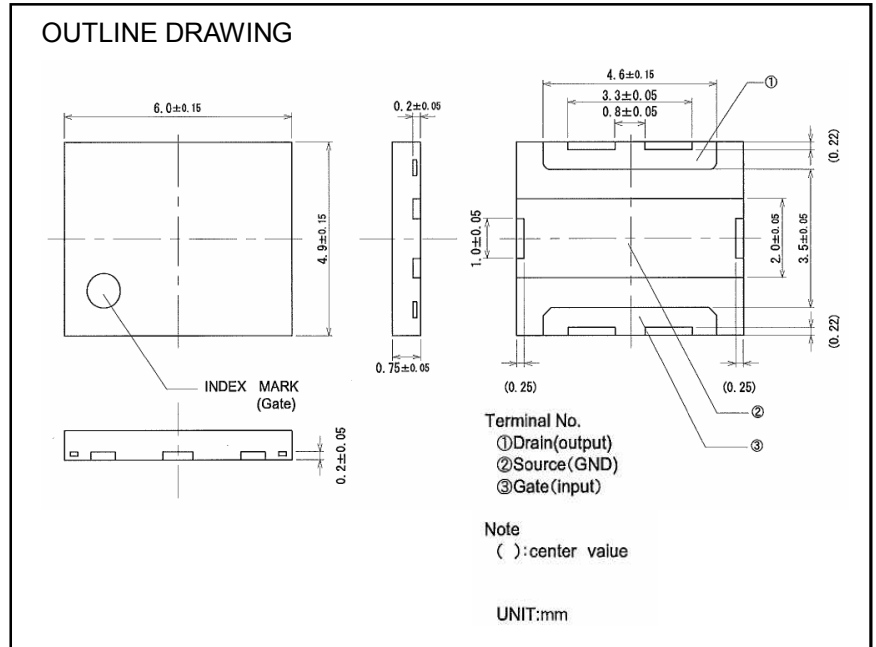
RD08MUS2 is a MOS FET type transistor specifically designed for VHF/UHF RF power amplifiers applications.

FEATURES

High power gain and High Efficiency.
 $P_{out}=7.5W_{min}$, Drain Effi. =62%min
 @ $V_{ds}=7.2V$, $I_{dq}=280mA$, $P_{in}=0.2W$, $f=527MHz$
 Integrated gate protection diode.

APPLICATION

For output stage of high power amplifiers in VHF/UHF-band mobile radio sets.



RoHS COMPLIANT

RD08MUS2-501, T512, T514 is EU RoHS compliant.
 RoHS compliance is indicating by the letter "G" after the Lot Marking.

ABSOLUTE MAXIMUM RATINGS (Tc=25°C UNLESS OTHERWISE NOTED)

SYMBOL	PARAMETER	CONDITIONS	RATINGS	UNIT
VDSS	Drain to source voltage	$V_{GS}=0V$	25	V
VGSS	Gate to source voltage	$V_{DS}=0V$	-5/+10	V
Pch*	Channel dissipation	$T_c=25^\circ C$	46	W
P _{in}	Input Power	$Z_g=Z_l=50\Omega$	0.8	W
P _{out}	Output Power	$Z_g=Z_l=50\Omega$	10	W
I _D	Drain Current	-	3.0	A
T _{ch}	Junction Temperature	-	150	°C
T _{stg}	Storage temperature	-	-40 to +125	°C

Note: Above parameters are guaranteed independently.

* Theoretical value in case of mounted on infinite heat sink.

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ELECTRICAL CHARACTERISTICS (T_c=25°C, UNLESS OTHERWISE NOTED)

SYMBOL	PARAMETER	CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX.	
I _{DSS}	Drain cutoff current	V _{DS} =17V, V _{GS} =0V	-	-	50	uA
I _{GSS}	Gate cutoff current	V _{GS} =5V, V _{DS} =0V	-	-	1	uA
V _{TH}	Gate threshold Voltage	V _{DS} =7.2V, I _{DS} =1mA	0.5	1	1.5	V
P _{out}	Output power	f=527MHz, V _{DD} =7.2V	7.5*	8.5*	-	W
η _D	Drain efficiency	P _{in} =0.2W, I _{dq} =280mA	62*	65*	-	%
VSWRT	Load VSWR tolerance	V _{DS} =9.5V, P _o =7.5W (Pin Control) f=135MHz, I _{dq} =280mA, Z _g =50Ω Load VSWR=20:1 (All Phase)	No destroy**			-

Note: Above parameters, ratings, limits and conditions are subject to change.

* In Mitsubishi 527MHz Test fixture with clamping mechanism.

** In Mitsubishi 135MHz Test fixture with clamping mechanism.

TEMPERATURE CHARACTERISTICS (T_c=25°C UNLESS OTHERWISE NOTED)

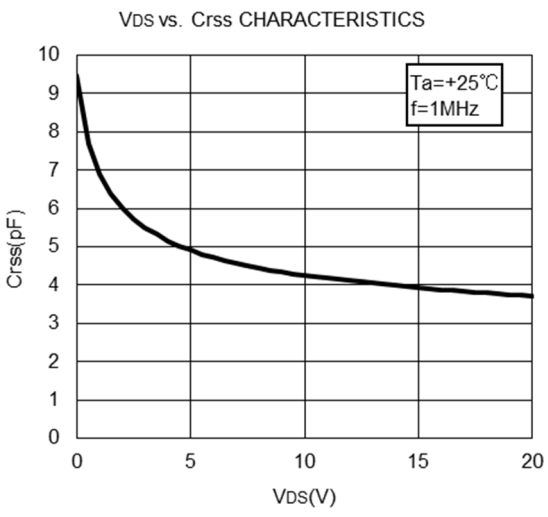
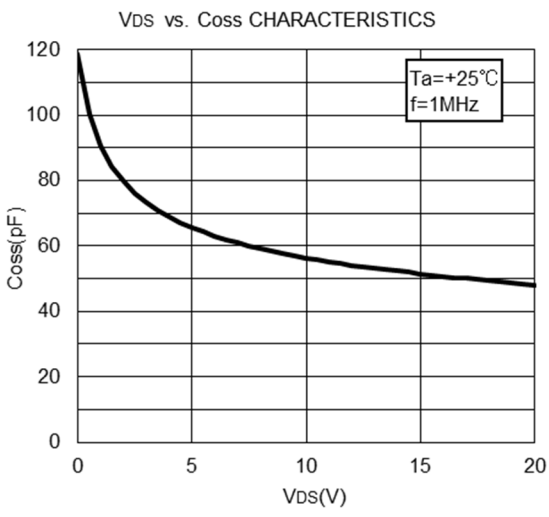
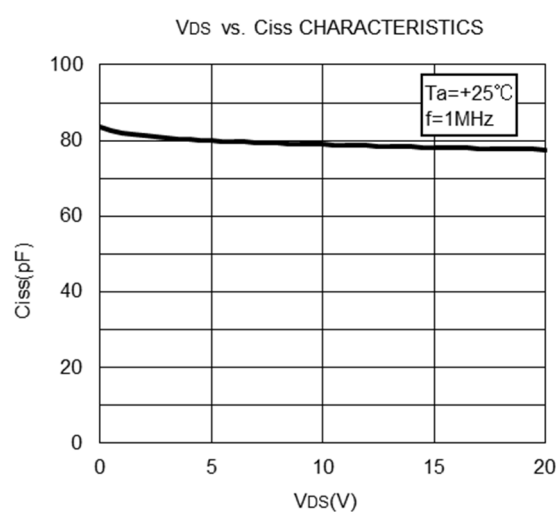
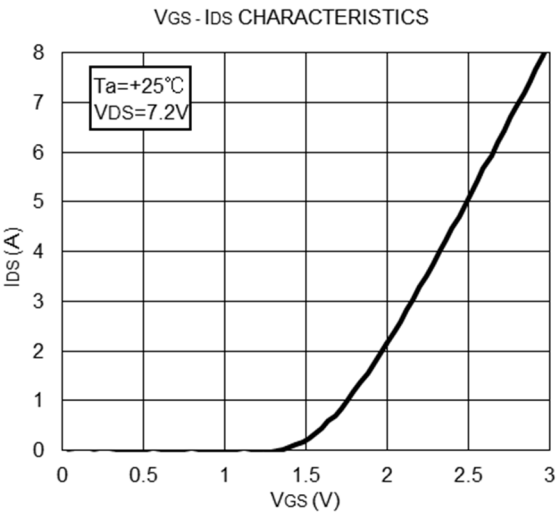
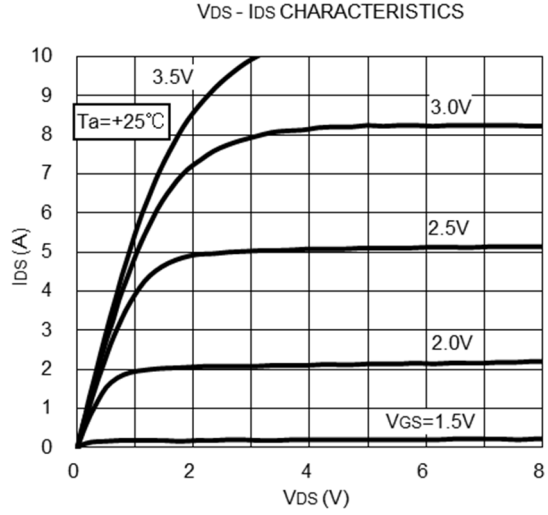
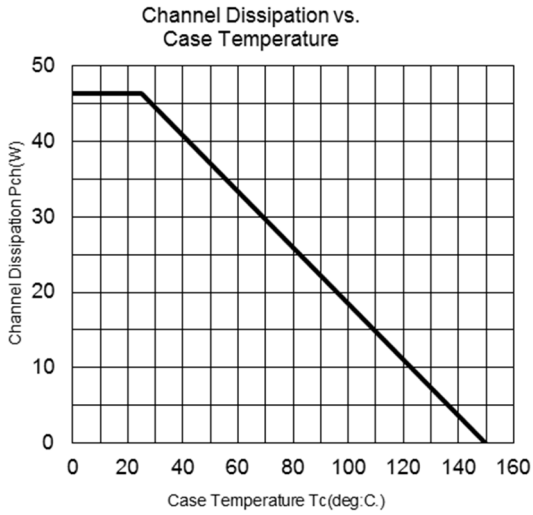
SYMBOL	PARAMETER	CONDITIONS	LIMITS			UNIT
			MIN	TYP	MAX	
R _{th(j-c)}	Thermal Resistance	Junction to Case	-	2.0	2.7	°C /W

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TYPICAL CHARACTERISTICS

(These are only typical curves and devices are not necessarily guaranteed at these curves.)



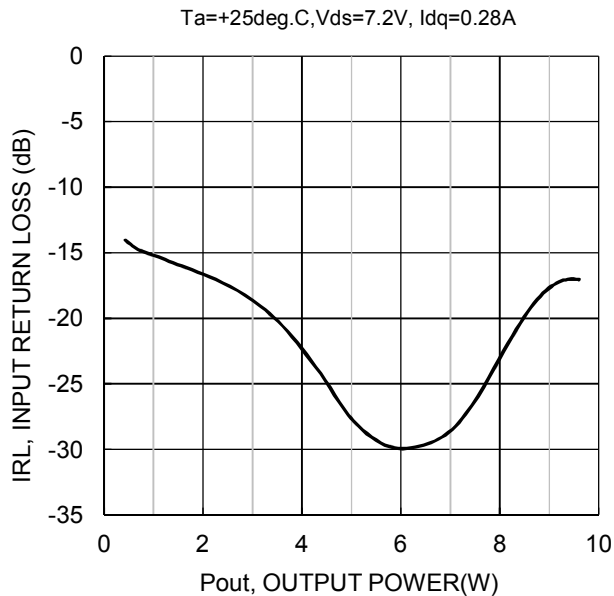
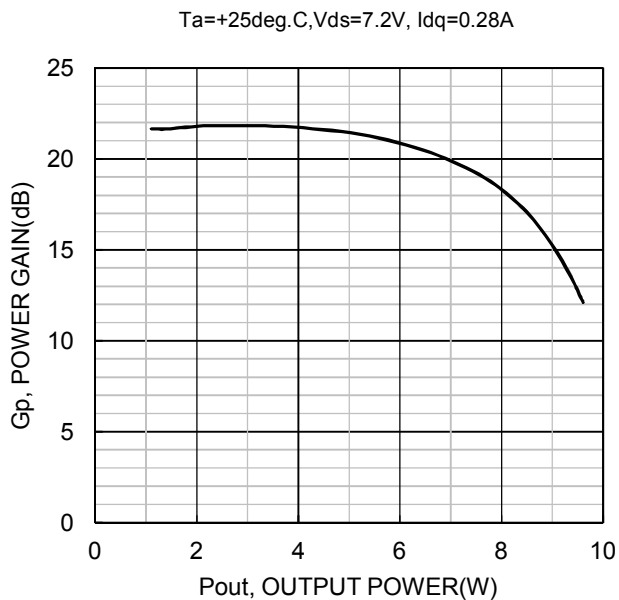
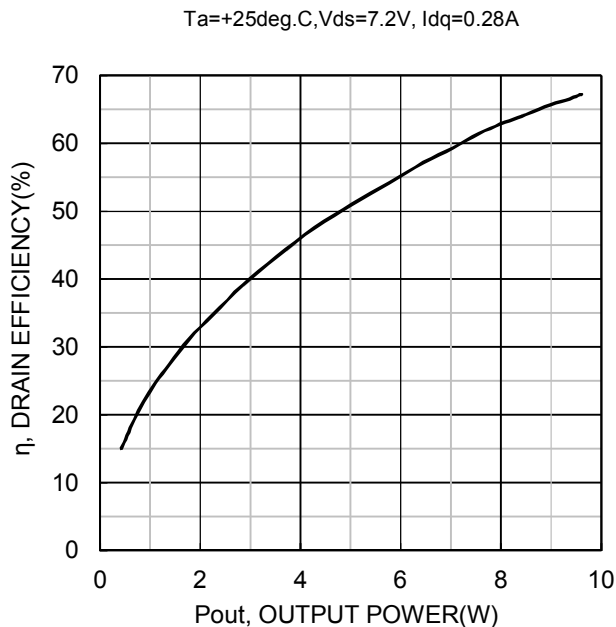
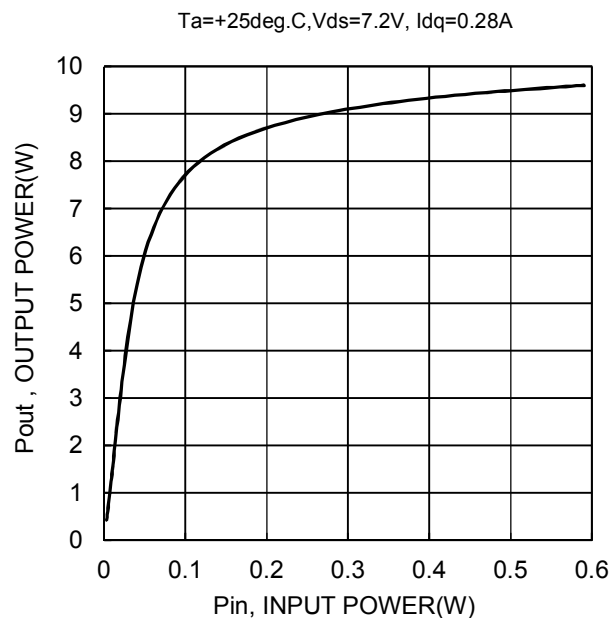
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Measured on 527MHz Narrow Band Test Fixture

TYPICAL CHARACTERISTICS (f=527MHz)

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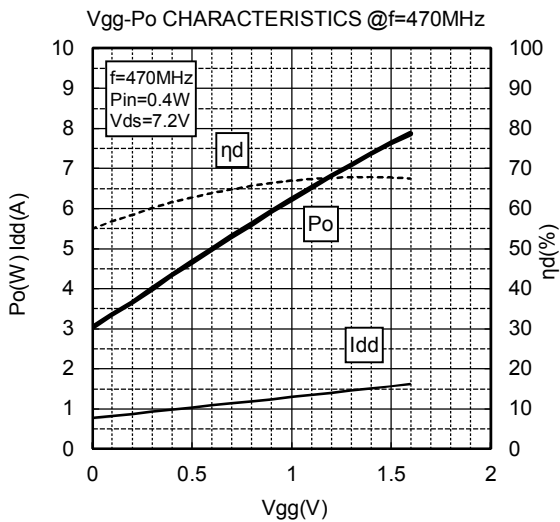
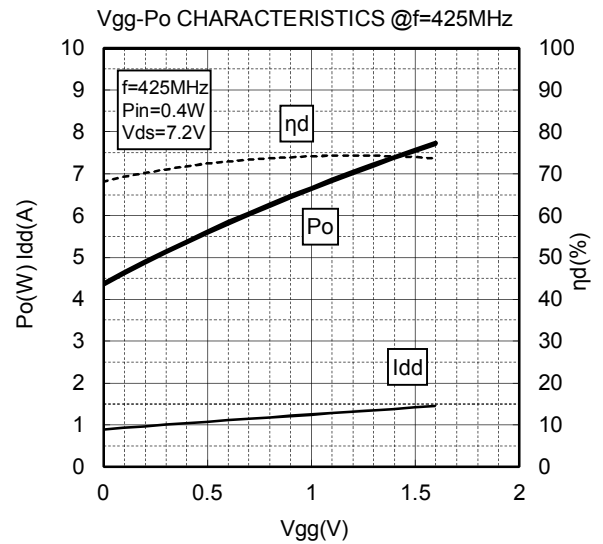
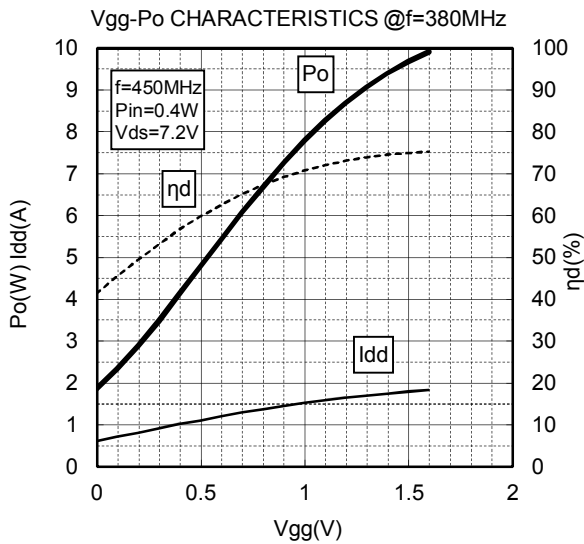
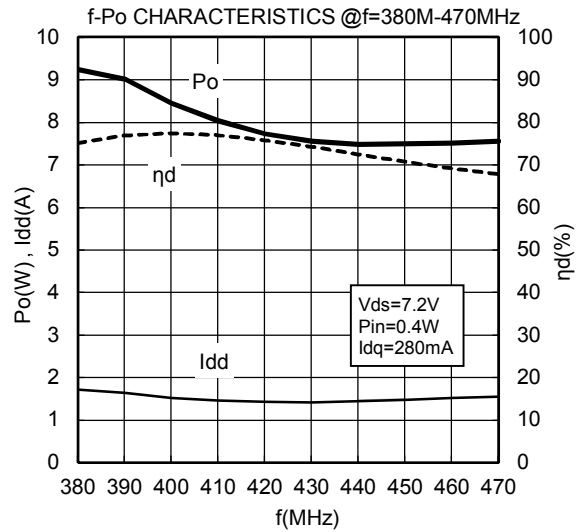
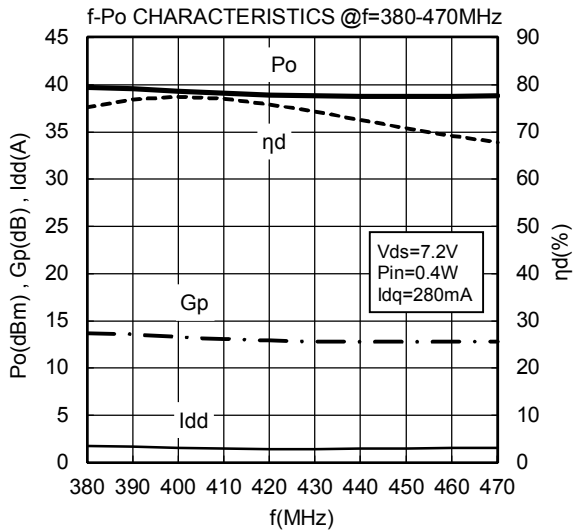


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TYPICAL CHARACTERISTICS (f=380-470MHz, Ta=+25°C)

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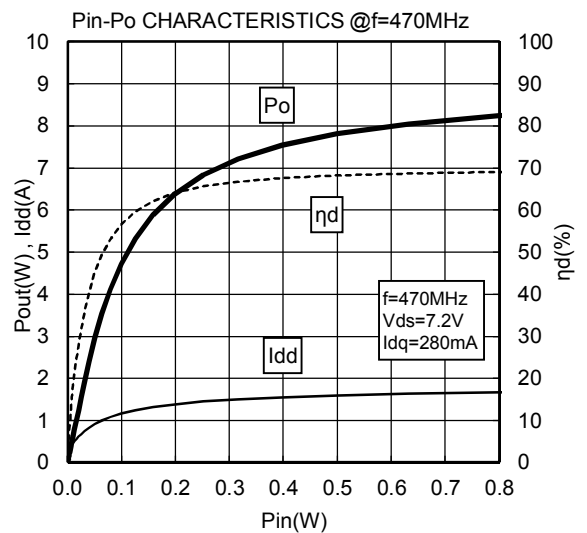
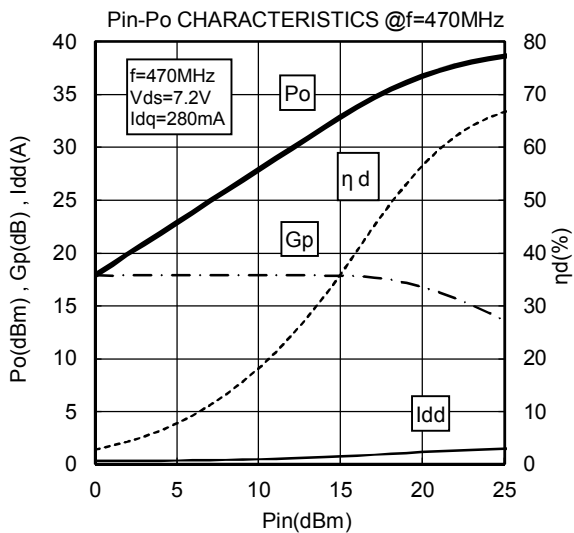
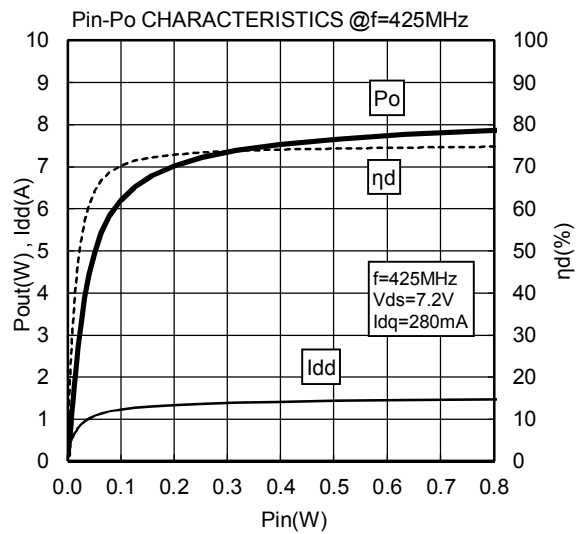
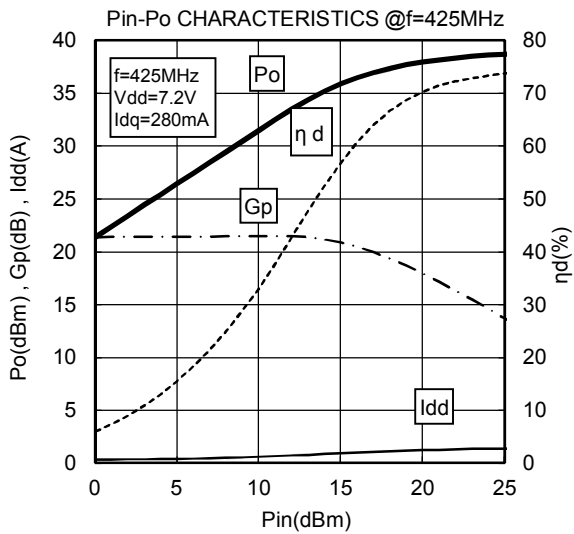
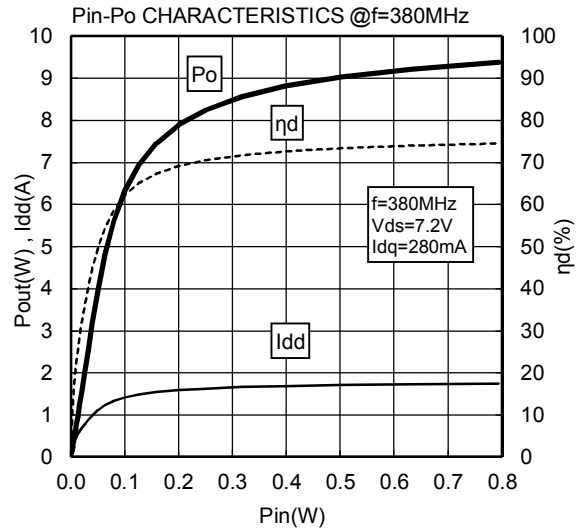
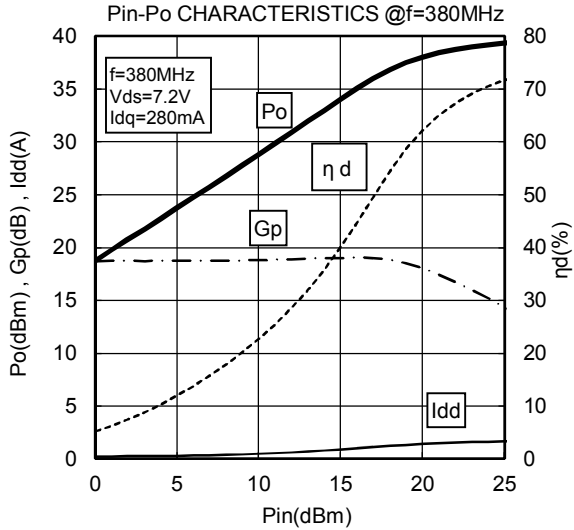


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TYPICAL CHARACTERISTICS (f=380-470MHz)

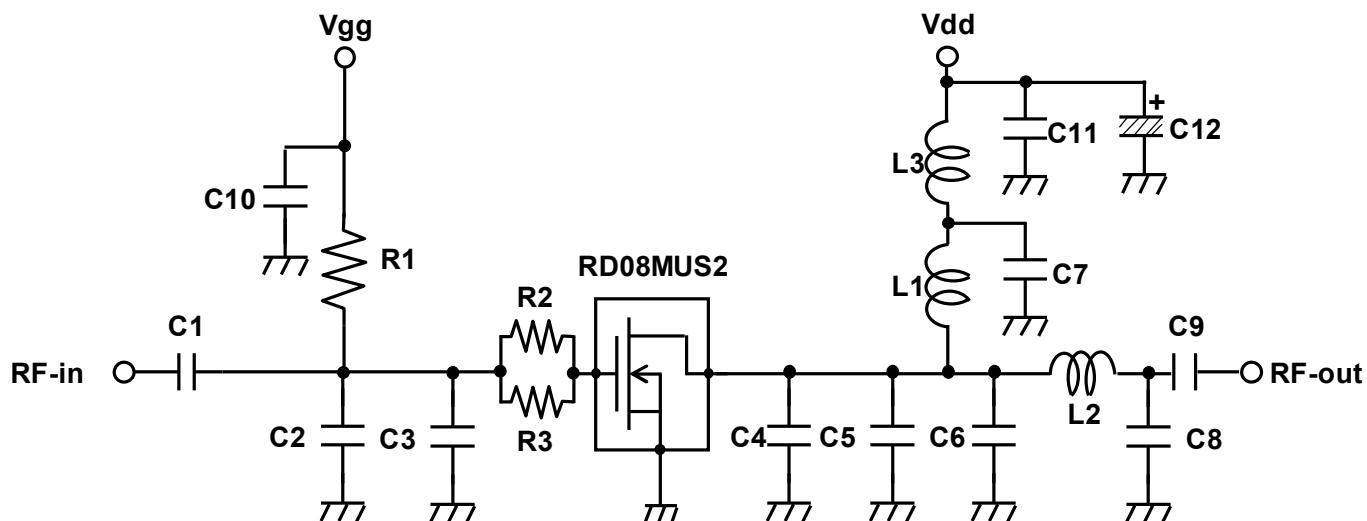
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EQUIVALENT CIRCUITRY for UHF Circuit for f=380-470MHz



<Note>

Board material - Glass-Epoxy Substrate(ϵ_r :4.8, t :0.8mm)

Micro strip Line width = 1.3mm / 50 Ω

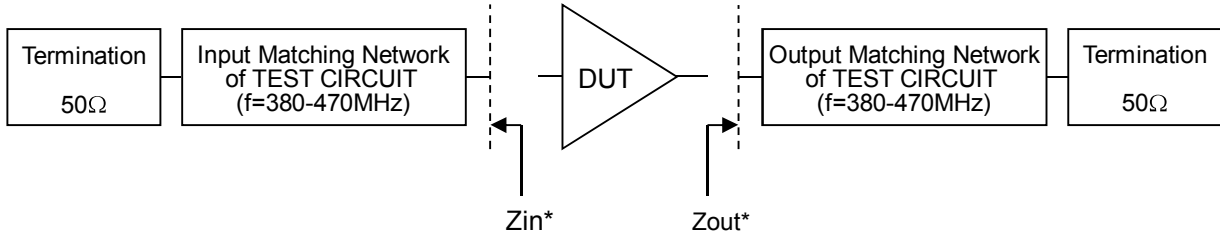
Part	Description	Part number	Manufacturer
C1, C9	100 pF	GRM2162C1H101JA01	MURATA MANUFACTURING CO.
C2	22 pF	GRM21A5C2D220JW01	MURATA MANUFACTURING CO.
C3	33 pF	GRM21A5C2D330JW01	MURATA MANUFACTURING CO.
C4	56 pF	GQM2192C1H560JB01	MURATA MANUFACTURING CO.
C5	22 pF	GQM2192C1H220JB01	MURATA MANUFACTURING CO.
C6, C8	12 pF	GRM21A5C2D120JW01	MURATA MANUFACTURING CO.
C7	8 pF	GRM1882C1H8R0CA01	MURATA MANUFACTURING CO.
C10, C11	1000 pF	GRM2162C1H102JA01	MURATA MANUFACTURING CO.
C12	22 μ F	UVZ1H220MDD	NICHICON CORPORATION
L1, L2	1 nH Copper bridge	-	-
L3	25nH Enameled wire 5Turns, Diameter:0.40mm, ϕ 2.46mm (the out side diameter)	4005A	Yoneda Processing Place Co.,Ltd.
R1	2.2 k Ω	RPC05 222-J	TAIYOSHA ELECTRIC CO.
R2, R3	1 Ω	RPC05 1R0-J	TAIYOSHA ELECTRIC CO.

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input / Output Impedance VS. Frequency Characteristics for f=450-527MHz

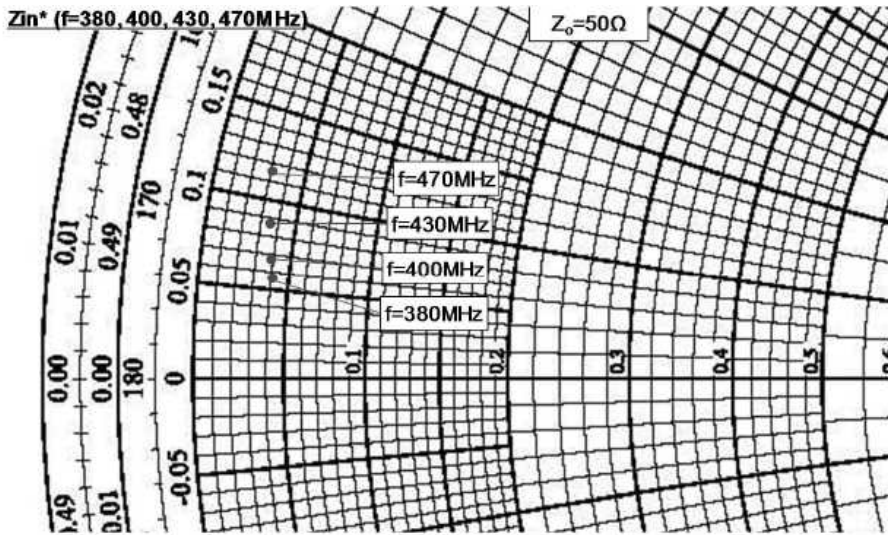
Method of Measurement



Zin*: Input Matching Network impedance measured from DUT

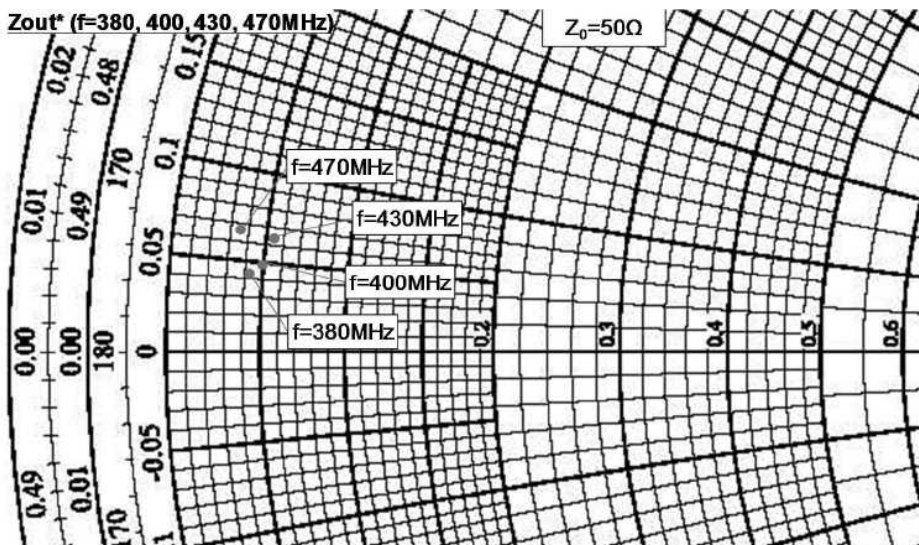
Zout*: Output Matching Network impedance measured from DUT

Z₀: Characteristic impedance



f (MHz)	Zin* (Ω)
380	2.17 + j 2.55
400	2.02 + j 3.31
430	1.88 + j 4.37
470	2.09 + j 5.92

Zin*: Complex conjugate of input impedance



f (MHz)	Zout* (Ω)
380	2.18 + j 2.08
430	2.51 + j 2.47
430	3.14 + j 2.58
470	3.45 + j 1.80

Zout*: Complex conjugate of output impedance

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RD08MUS2 S-Parameter data (Vdd=7.2V, Id=280mA)

Freq. (MHz)	S11		S21		S12		S22	
	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)
100	0.84	-171	9.78	78	0.02	-10	0.77	-170
135	0.85	-172	7.09	72	0.01	-15	0.78	-171
155	0.86	-173	6.07	69	0.01	-18	0.79	-171
175	0.86	-173	5.29	66	0.01	-21	0.80	-171
200	0.87	-174	4.52	62	0.01	-24	0.81	-171
250	0.88	-175	3.42	56	0.01	-29	0.83	-172
300	0.89	-175	2.69	50	0.01	-34	0.85	-172
350	0.91	-176	2.16	45	0.01	-38	0.87	-173
380	0.91	-177	1.92	42	0.01	-40	0.88	-174
400	0.92	-177	1.78	40	0.01	-41	0.88	-174
435	0.92	-177	1.56	37	0.01	-43	0.89	-174
450	0.92	-178	1.48	36	0.01	-43	0.90	-174
470	0.93	-178	1.38	34	0.01	-44	0.90	-175
500	0.93	-178	1.25	32	0.01	-45	0.91	-175
527	0.94	-179	1.15	31	0.01	-46	0.91	-175
550	0.94	-179	1.07	29	0.01	-47	0.91	-176
600	0.94	-180	0.93	26	0.01	-48	0.92	-176
650	0.95	179	0.81	24	0.01	-48	0.93	-177
700	0.95	179	0.71	21	0.00	-47	0.94	-178
750	0.95	178	0.64	19	0.00	-45	0.94	-178
800	0.96	177	0.57	17	0.00	-41	0.95	-179
850	0.96	177	0.51	15	0.00	-38	0.95	-180
900	0.96	176	0.46	14	0.00	-31	0.95	180
950	0.96	175	0.42	12	0.00	-22	0.95	179
1000	0.96	175	0.38	10	0.00	-7	0.96	179

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ATTENTION:

- 1.High Temperature ; This product might have a heat generation while operation,Please take notice that have a possibility to receive a burn to touch the operating product directly or touch the product until cold after switch off. At the near the product,do not place the combustible material that have possibilities to arise the fire
- 2.Generation of High Frequency Power ; This product generate a high frequency power. Please take notice that do not leakage the unnecessary electric wave and use this products without cause damage for human and property per normal operation.
- 3.Before use; Before use the product,Please design the equipment in consideration of the risk for human and electric wave obstacle for equipment.

PRECAUTIONS FOR THE USE OF MITSUBISHI SILICON RF POWER DEVICES:

1. The specifications of mention are not guarantee values in this data sheet. Please confirm additional details regarding operation of these products from the formal specification sheet. For copies of the formal specification sheets, please contact one of our sales offices.
- 2.RA series products (RF power amplifier modules) and RD series products (RF power transistors) are designed for consumer mobile communication terminals and were not specifically designed for use in other applications.
In particular, while these products are highly reliable for their designed purpose, they are not manufactured under a quality assurance testing protocol that is sufficient to guarantee the level of reliability typically deemed necessary for critical communications elements and In the application, which is base station applications and fixed station applications that operate with long term continuous transmission and a higher on-off frequency during transmitting, please consider the derating, the redundancy system, appropriate setting of the maintain period and others as needed. For the reliability report which is described about predicted operating life time of Mitsubishi Silicon RF Products , please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor.
3. RD series products use MOSFET semiconductor technology. They are sensitive to ESD voltage therefore appropriate ESD precautions are required.
4. In the case of use in below than recommended frequency, there is possibility to occur that the device is deteriorated or destroyed due to the RF-swing exceed the breakdown voltage.
5. In order to maximize reliability of the equipment, it is better to keep the devices temperature low. It is recommended to utilize a sufficient sized heat-sink in conjunction with other cooling methods as needed (fan, etc.) to keep the channel temperature for RD series products lower than 120deg/C(in case of Tchmax=150deg/C) ,140deg/C(in case of Tchmax=175deg/C) under standard conditions.
6. Do not use the device at the exceeded the maximum rating condition. In case of plastic molded devices, the exceeded maximum rating condition may cause blowout, smoldering or catch fire of the molding resin due to extreme short current flow between the drain and the source of the device. These results causes in fire or injury.
7. For specific precautions regarding assembly of these products into the equipment, please refer to the supplementary items in the specification sheet.
8. Warranty for the product is void if the products protective cap (lid) is removed or if the product is modified in any way from it's original form.
9. For additional "Safety first" in your circuit design and notes regarding the materials, please refer the last page of this data sheet.

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10. Please avoid use in the place where water or organic solvents can adhere directly to the product and the environments with the possibility of caustic gas, dust, salinity, etc.

Reliability could be markedly decreased and also there is a possibility failures could result causing a serious accident. Likewise, there is a possibility of causing a serious accident if used in an explosive gas environment. Please allow for adequate safety margin in your designs.

11. Please refer to the additional precautions in the formal specification sheet.

Keep safety first in your circuit designs!

Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of non-flammable material or (iii) prevention against any malfunction or mishap.

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